

**Boost chopper  
SiC FWD diode  
Super Junction  
MOSFET Power Module**

**V<sub>DSS</sub> = 600V**  
**R<sub>DSon</sub> = 18mΩ max @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 143A @ T<sub>c</sub> = 25°C**

**Application**

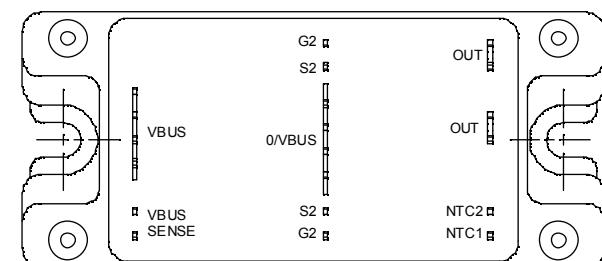
- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

**Features**

- **COOLMOS®**  
**Power Semiconductors**
  - Ultra low R<sub>DSon</sub>
  - Low Miller capacitance
  - Ultra low gate charge
  - Avalanche energy rated
- **FWD SiC Schottky Diode**
  - Zero reverse recovery
  - Zero forward recovery
  - Temperature Independent switching behavior
  - Positive temperature coefficient on VF
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration

**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS compliant



**Absolute maximum ratings**

| Symbol            | Parameter   | Max ratings           | Unit |
|-------------------|---|-----------------------|------|
| V <sub>DSS</sub>  | Drain - Source Breakdown Voltage                  | 600                   | V    |
| I <sub>D</sub>    | Continuous Drain Current                          | T <sub>c</sub> = 25°C | A    |
|                   |   | T <sub>c</sub> = 80°C |      |
| I <sub>DM</sub>   | Pulsed Drain current                              | 572                   |      |
| V <sub>GS</sub>   | Gate - Source Voltage                             | ±30                   | V    |
| R <sub>DSon</sub> | Drain - Source ON Resistance                      | 18                    | mΩ   |
| P <sub>D</sub>    | Maximum Power Dissipation                         | T <sub>c</sub> = 25°C | W    |
| I <sub>AR</sub>   | Avalanche current (repetitive and non repetitive) | 20                    | A    |
| E <sub>AR</sub>   | Repetitive Avalanche Energy                       | 1                     | mJ   |
| E <sub>AS</sub>   | Single Pulse Avalanche Energy                     | 1800                  |      |

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

### Electrical Characteristics

| Symbol       | Characteristic                  | Test Conditions                                | Min                       | Typ | Max       | Unit             |
|--------------|---------------------------------|--|---------------------------|-----|-----------|------------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}, V_{DS} = 600\text{V}$     | $T_j = 25^\circ\text{C}$  |     | 100       | $\mu\text{A}$    |
|              |                                 | $V_{GS} = 0\text{V}, V_{DS} = 600\text{V}$     | $T_j = 125^\circ\text{C}$ |     | 1000      |                  |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10\text{V}, I_D = 71.5\text{A}$      |                           |     | 18        | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 4\text{mA}$            | 2.1                       | 3   | 3.9       | $\text{V}$       |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{V}$ |                           |     | $\pm 200$ | $\text{nA}$      |

### Dynamic Characteristics

| Symbol       | Characteristic               | Test Conditions  | Min | Typ  | Max | Unit          |
|--------------|------------------------------|--|-----|------|-----|---------------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$   |     | 28   |     | $\text{nF}$   |
| $C_{oss}$    | Output Capacitance           |  |     | 10.2 |     |               |
| $C_{rss}$    | Reverse Transfer Capacitance |  |     | 0.85 |     |               |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10\text{V}$<br>$V_{Bus} = 300\text{V}$<br>$I_D = 143\text{A}$  |     | 1036 |     | $\text{nC}$   |
| $Q_{gs}$     | Gate – Source Charge         |  |     | 116  |     |               |
| $Q_{gd}$     | Gate – Drain Charge          |  |     | 444  |     |               |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Inductive switching @ 125°C</b><br>$V_{GS} = 15\text{V}$<br>$V_{Bus} = 400\text{V}$<br>$I_D = 143\text{A}$<br>$R_G = 1.2\Omega$ |     | 21   |     | $\text{ns}$   |
| $T_r$        | Rise Time                    |  |     | 30   |     |               |
| $T_{d(off)}$ | Turn-off Delay Time          |  |     | 283  |     |               |
| $T_f$        | Fall Time                    |  |     | 84   |     |               |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ 25°C</b><br>$V_{GS} = 15\text{V}, V_{Bus} = 400\text{V}$<br>$I_D = 143\text{A}, R_G = 1.2\Omega$          |     | 1608 |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    |  |     | 3920 |     |               |
| $E_{on}$     | Turn-on Switching Energy     |  |     | 2630 |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    | <b>Inductive switching @ 125°C</b><br>$V_{GS} = 15\text{V}, V_{Bus} = 400\text{V}$<br>$I_D = 143\text{A}, R_G = 1.2\Omega$         |     | 4824 |     |               |

### Chopper diode ratings and characteristics

| Symbol    | Characteristic                          | Test Conditions  | Min                       | Typ | Max | Unit        |
|-----------|---|--|---------------------------|-----|-----|-------------|
| $V_{RRM}$ | Maximum Peak Repetitive Reverse Voltage |  | 600                       |     |     | $\text{V}$  |
| $I_{RM}$  | Maximum Reverse Leakage Current         | $V_R = 600\text{V}$  | $T_j = 25^\circ\text{C}$  |     | 2   | $\text{mA}$ |
|           |   |  | $T_j = 175^\circ\text{C}$ |     | 10  |             |
| $I_F$     | DC Forward Current                      |  | $T_c = 125^\circ\text{C}$ | 100 |     | $\text{A}$  |
| $V_F$     | Diode Forward Voltage                   | $I_F = 100\text{A}$  | $T_j = 25^\circ\text{C}$  | 1.6 | 1.8 | $\text{V}$  |
|           |   |  | $T_j = 175^\circ\text{C}$ | 2.0 | 2.4 |             |
| $Q_C$     | Total Capacitive Charge                 | $I_F = 100\text{A}, V_R = 300\text{V}$<br>$di/dt = 2400\text{A}/\mu\text{s}$ |                           | 140 |     | $\text{nC}$ |
| $C$       | Total Capacitance                       | $f = 1\text{MHz}, V_R = 200\text{V}$   |                           | 650 |     | $\text{pF}$ |
|           |   | $f = 1\text{MHz}, V_R = 400\text{V}$   |                           | 500 |     |             |

**Thermal and package characteristics**
**Symbol      Characteristic**

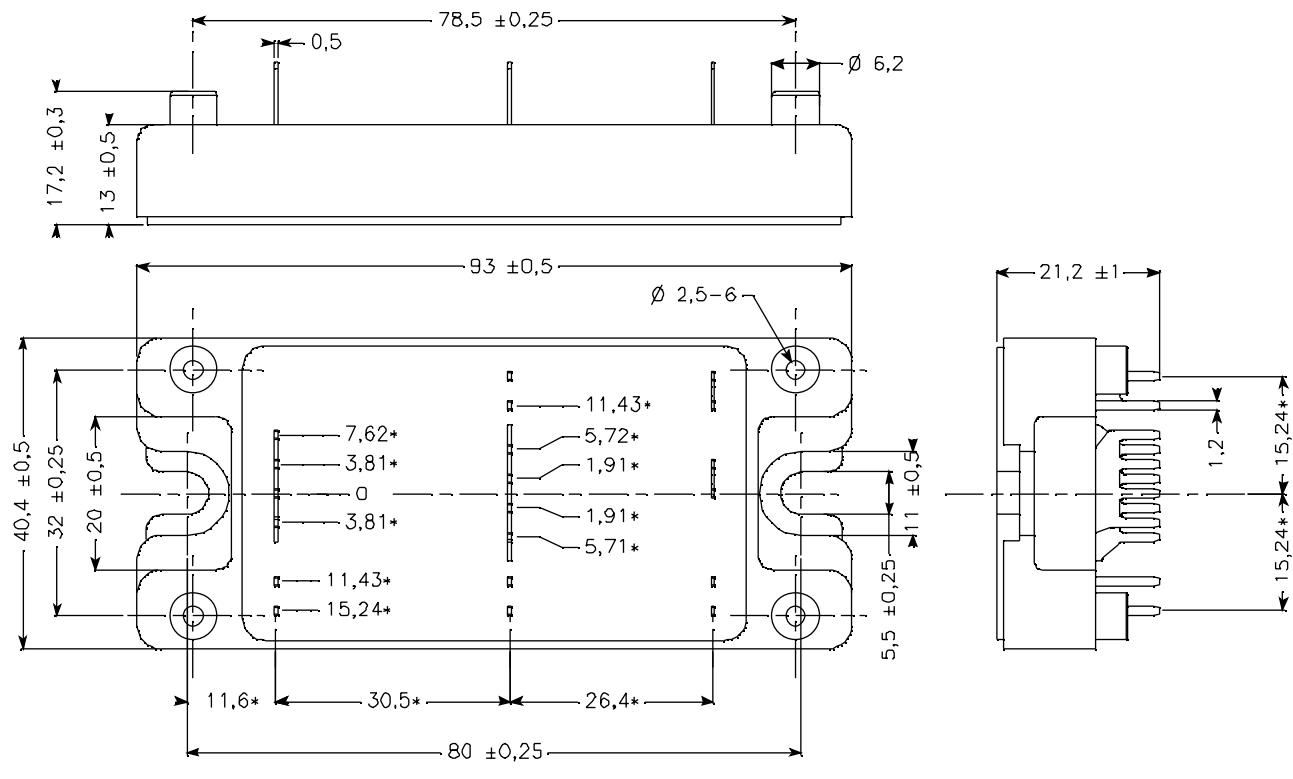
|            |  |             | <i>Min</i> | <i>Typ</i> | <i>Max</i> | <i>Unit</i> |
|------------|--|-------------|------------|------------|------------|-------------|
| $R_{thJC}$ | Junction to Case Thermal Resistance  | Transistor  |            |            | 0.15       | °C/W        |
|            |  | Diode       |            |            | 0.28       |             |
| $V_{ISOL}$ | RMS Isolation Voltage, any terminal to case t = 1 min, I isol < 1mA, 50/60Hz |             | 2500       |            |            | V           |
| $T_J$      | Operating junction temperature range   |             | -40        |            | 150        | °C          |
| $T_{STG}$  | Storage Temperature Range  |             | -40        |            | 125        |             |
| $T_C$      | Operating Case Temperature   |             | -40        |            | 100        |             |
| Torque     | Mounting torque  | To heatsink | M5         | 1.5        | 4.7        | N.m         |
| Wt         | Package Weight   |             |            |            | 160        | g           |

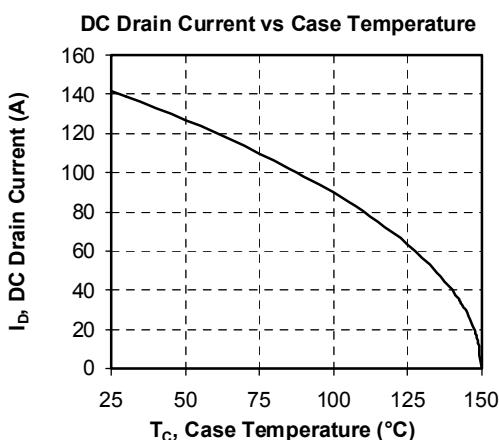
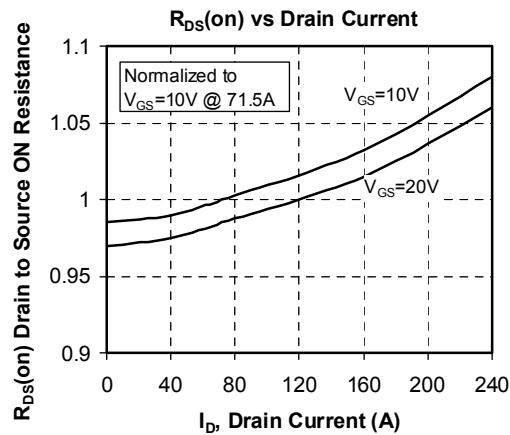
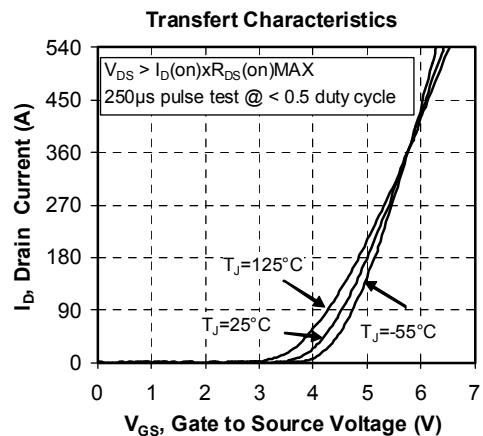
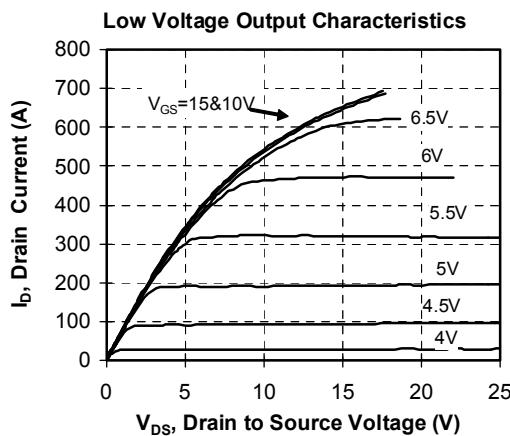
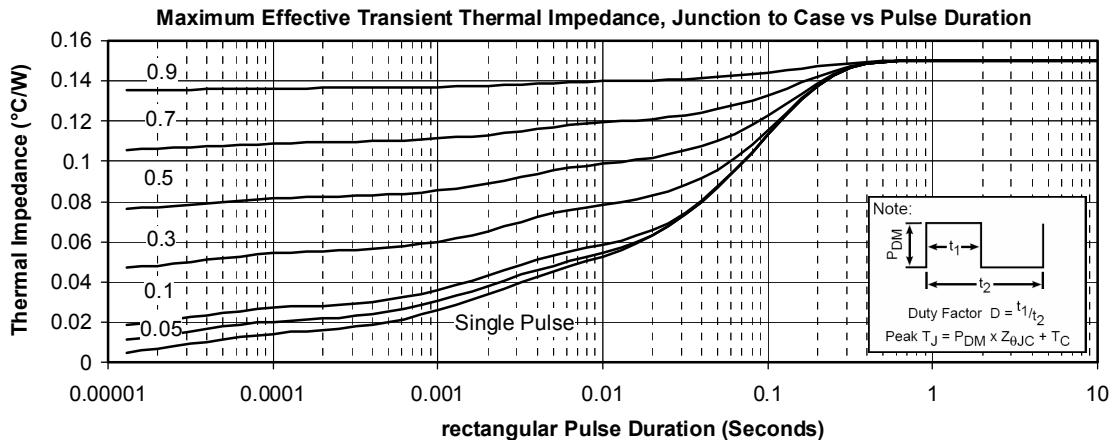
**Temperature sensor NTC** (see application note APT0406 on www.advancedpower.com for more information)

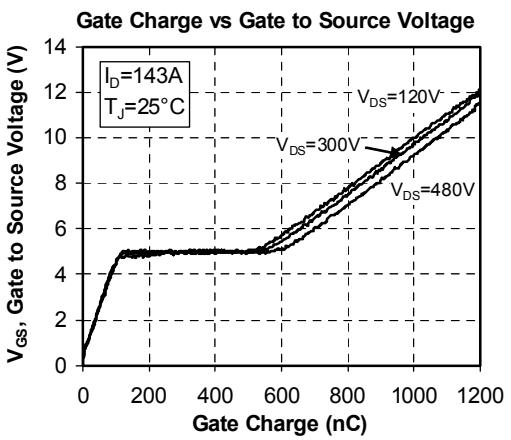
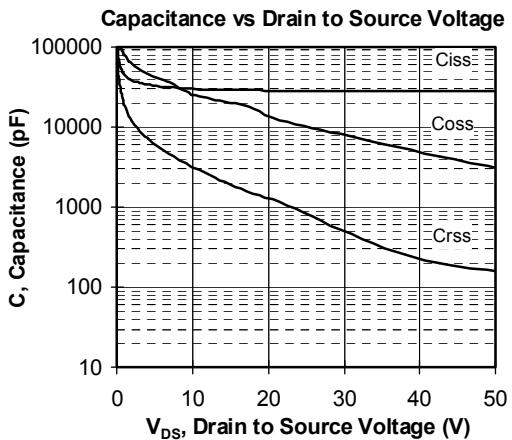
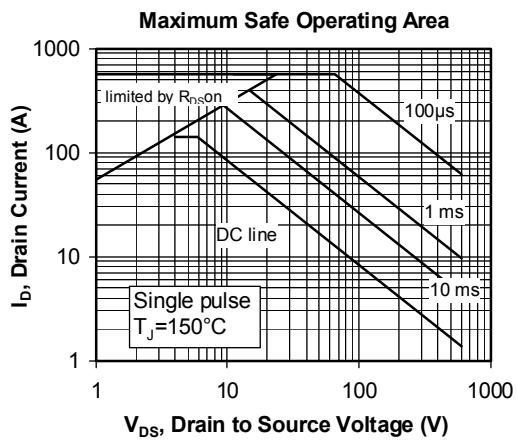
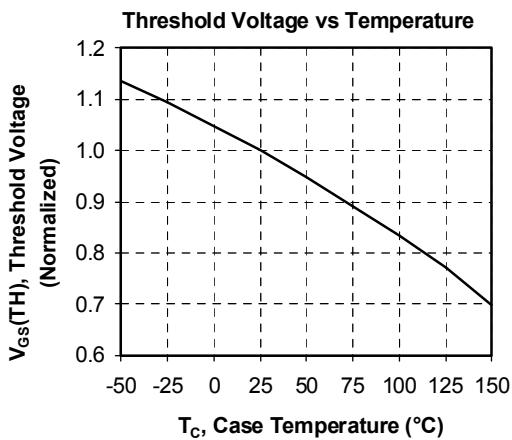
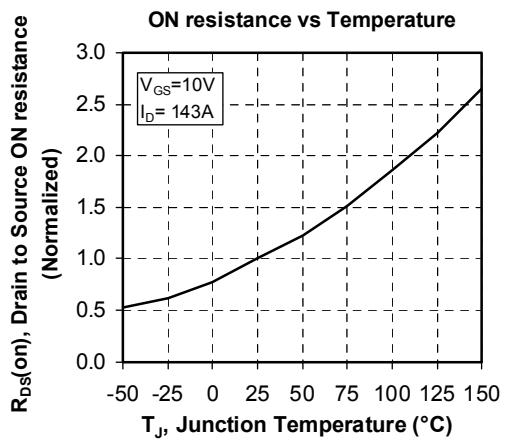
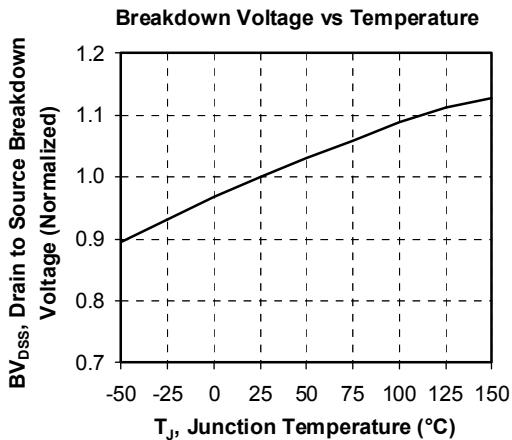
**Symbol      Characteristic**

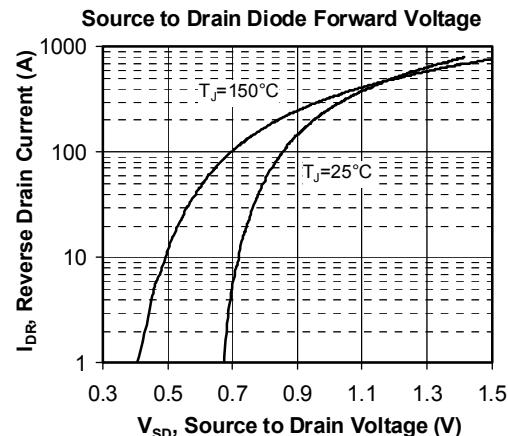
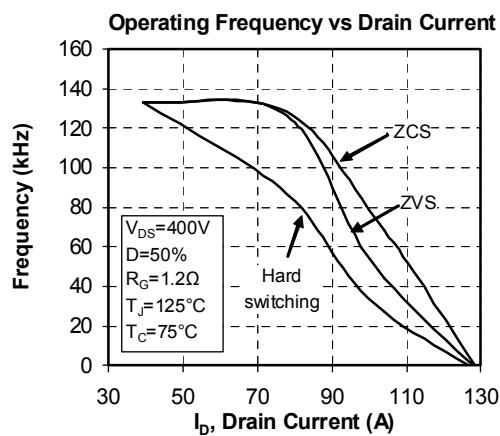
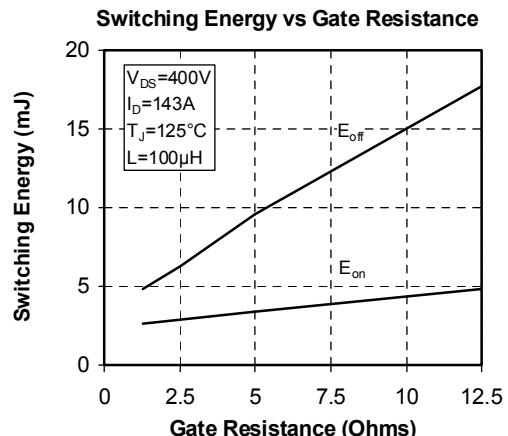
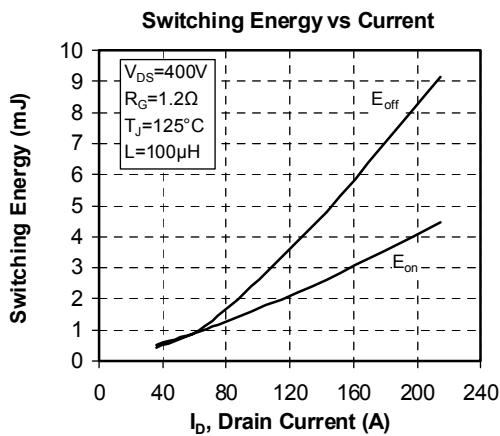
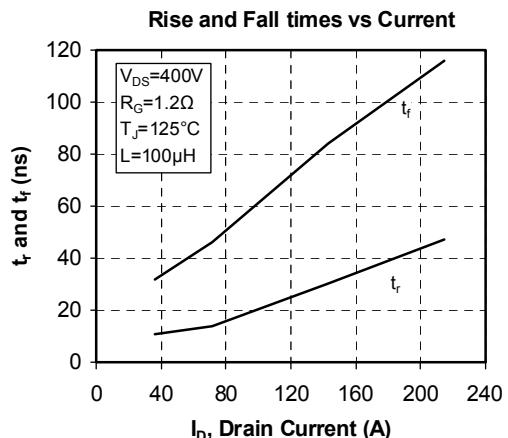
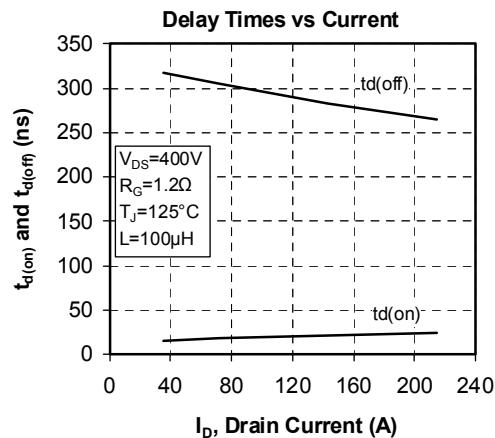
|             |                             |  | <i>Min</i> | <i>Typ</i> | <i>Max</i> | <i>Unit</i> |
|-------------|-----------------------------|--|------------|------------|------------|-------------|
| $R_{25}$    | Resistance @ 25°C           |  |            | 50         |            | kΩ          |
| $B_{25/85}$ | $T_{25} = 298.15 \text{ K}$ |  |            | 3952       |            | K           |

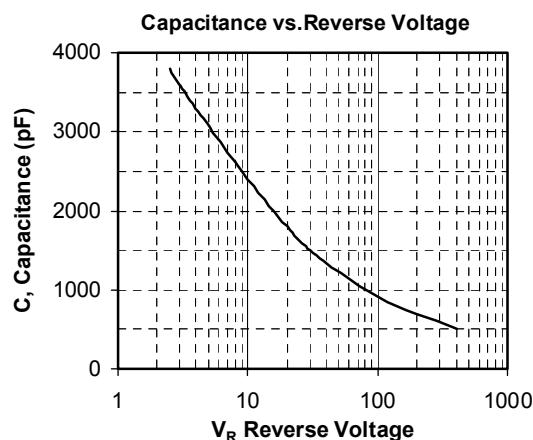
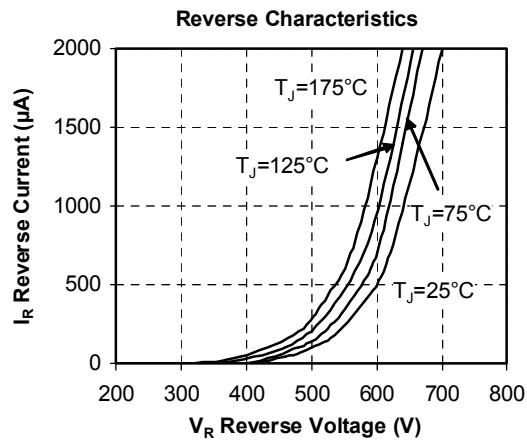
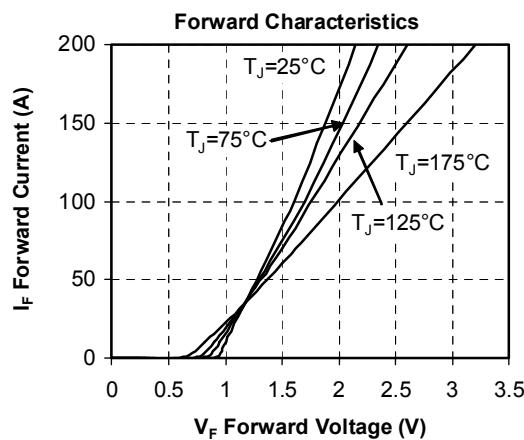
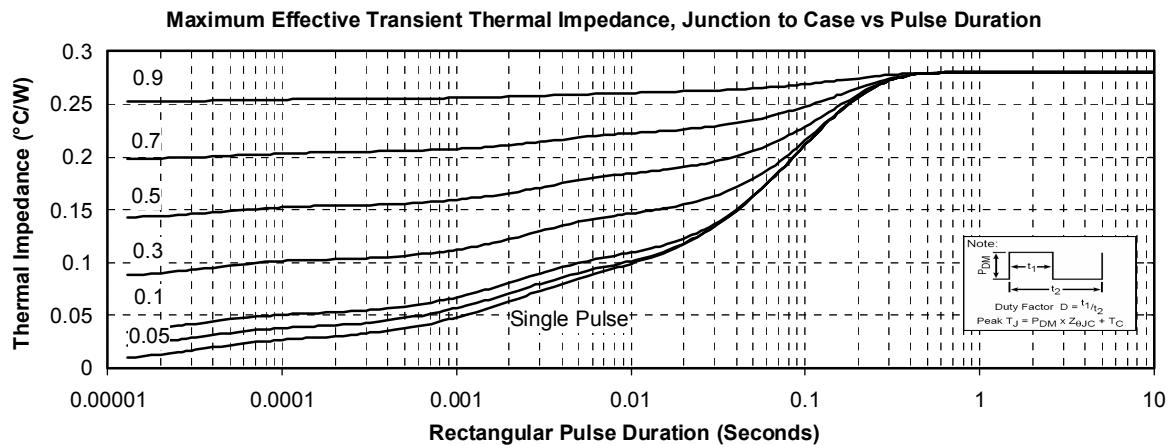
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad \begin{array}{l} T: \text{Thermistor temperature} \\ R_T: \text{Thermistor value at } T \end{array}$$

**SP4 Package outline (dimensions in mm)**

 ALL DIMENSIONS MARKED " \* " ARE TOLERENCED AS : 

**Typical CoolMOS Performance Curve**






**Typical SiC Diode Performance Curve**


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